

### Product Change Notification / ALAN-22WDFU453

## Date:

16-Mar-2023

# **Product Category:**

Switching Regulators

# **PCN Type:**

Manufacturing Change

## **Notification Subject:**

CCB 4386.002 Final Notice: Qualification of Microchip Technology Tempe - Fab 2 (TMGR) as new fabrication site for Die#2 and Die#3 for selected MIC2851xx device families in 32L VQFN (6x6x0.9mm) package.

### Affected CPNs:

ALAN-22WDFU453\_Affected\_CPN\_03162023.pdf ALAN-22WDFU453\_Affected\_CPN\_03162023.csv

### Notification Text:

PCN Status: Final Notification

PCN Type: Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section. Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of Microchip Technology Tempe - Fab 2 (TMGR) as new fabrication site for Die#2 and Die#3 for selected MIC2851xx device families in 32L VQFN (6x6x0.9mm) package.

#### Pre and Post Change Summary:

	Pre Change	Post Change
		Page 1 of 3

	Die # 1	Microchip Technology Colorado (MCSO)	Microchip Technology Colorado (MCSO)				
Fabrication Location	Die # 2 MaxPower Semiconductor (MAPW)		Microchip Technology Tempe - Fab 2 (TMGR)				
	Die # 3	MaxPower Semiconductor (MAPW)	Microchip Technology Tempe - Fab 2 (TMGR)				
Wafer Size	Die # 1	6 inches	6 inches				
water Size	Die # 2 and Die # 3	8 inches	8 inches				

### Impacts to Data Sheet:None

### Change ImpactNone

**Reason for Change:**To improve manufacturability and on-time delivery performance by qualifying TMGR as new fabrication site for Die#2 and Die#3.

### Change Implementation Status: In Progress

Estimated First Ship Date: March 31, 2023 (date code: 2313)

Note: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

#### Time Table Summary:

	September 2022				>	March 2023					
Workweek	3	3	3	3	4		0	1	1	1	1
VVOLKWEEK	6	7	8	9	0		9	0	1	2	3
Initial PCN Issue			v								
Date			Х								
Qual Report									V		
Availability									Х		
Final PCN Issue									V		
Date									Х		
Estimated											
Implementation											Х
Date											

Method to Identify Change:Traceability code

**Qualification Report:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Report.

#### **Revision History:**

September 13, 2021: Issued initial notification.

March 16, 2023: Issued final notification. Attached the Qualification Report. Provided estimated first ship date to be on March 31, 2023.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

## Attachments:

PCN\_ALAN-22WDFU453\_Qual\_Report.pdf

Please contact your local Microchip sales office with questions or concerns regarding this notification.

### Terms and Conditions:

If you wish to <u>receive Microchip PCNs via email</u> please register for our PCN email service at our PCN home page select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the PCN FAQ section.

If you wish to <u>change your PCN profile</u>, <u>including opt out</u>, please go to the <u>PCN home page</u> select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections. ALAN-22WDFU453 - CCB 4386.002 Final Notice: Qualification of Microchip Technology Tempe - Fab 2 (TMGR) as new fabrication site for Die#2 and Die#3 for selected MIC2851xx device families in 32L VQFN (6x6x0.9mm) package.

Affected Catalog Part Numbers (CPN)

MIC28516T-E/PHA MIC28516T-E/PHAVAO MIC28517T-E/PHA MIC28517T-E/PHAVAO